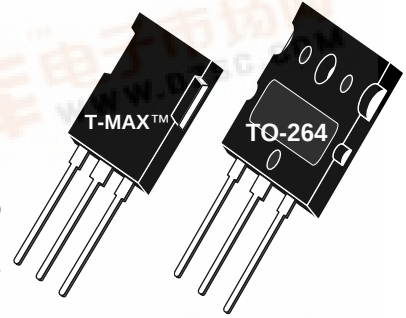




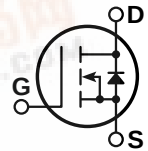
APT11044B2FLL
APT11044LFLL
1100V 26A 0.440Ω

POWER MOS 7[®] FREDFET

Power MOS 7[®] is a new generation of low loss, high voltage, N-Channel enhancement mode power MOSFETS. Both conduction and switching losses are addressed with Power MOS 7[®] by significantly lowering $R_{DS(ON)}$ and Q_g . Power MOS 7[®] combines lower conduction and switching losses along with exceptionally fast switching speeds inherent with APT's patented metal gate structure.



- Lower Input Capacitance
- Lower Miller Capacitance
- Lower Gate Charge, Q_g
- Increased Power Dissipation
- Easier To Drive
- Popular T-MAX[™] or TO-264 Package
- **FAST RECOVERY BODY DIODE**



MAXIMUM RATINGS

All Ratings: $T_C = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	APT11044JFLL	UNIT
V_{DSS}	Drain-Source Voltage	1100	Volts
I_D	Continuous Drain Current @ $T_C = 25^\circ\text{C}$	26	Amps
I_{DM}	Pulsed Drain Current ^①	104	
V_{GS}	Gate-Source Voltage Continuous	± 30	Volts
V_{GSM}	Gate-Source Voltage Transient	± 40	
P_D	Total Power Dissipation @ $T_C = 25^\circ\text{C}$	694	Watts
	Linear Derating Factor	5.56	W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150	$^\circ\text{C}$
T_L	Lead Temperature: 0.063" from Case for 10 Sec.	300	
I_{AR}	Avalanche Current ^① (Repetitive and Non-Repetitive)	26	Amps
E_{AR}	Repetitive Avalanche Energy ^①	50	mJ
E_{AS}	Single Pulse Avalanche Energy ^④	3000	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV_{DSS}	Drain-Source Breakdown Voltage ($V_{GS} = 0V, I_D = 250\mu A$)	1100			Volts
$R_{DS(on)}$	Drain-Source On-State Resistance ^② ($V_{GS} = 10V, 13A$)			0.440	Ohms
I_{DSS}	Zero Gate Voltage Drain Current ($V_{DS} = 1100V, V_{GS} = 0V$)			250	μA
	Zero Gate Voltage Drain Current ($V_{DS} = 880V, V_{GS} = 0V, T_C = 125^\circ\text{C}$)			1000	
I_{GSS}	Gate-Source Leakage Current ($V_{GS} = \pm 30V, V_{DS} = 0V$)			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage ($V_{DS} = V_{GS}, I_D = 2.5mA$)	3		5	Volts

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

DYNAMIC CHARACTERISTICS

APT11044B2FLL - LFLL

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{iss}	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1\text{ MHz}$		5643		pF
C_{oss}	Output Capacitance			828		
C_{rss}	Reverse Transfer Capacitance			153		
Q_g	Total Gate Charge ③	$V_{GS} = 10V$ $V_{DD} = 550V$ $I_D = 22A @ 25^\circ C$		180		nC
Q_{gs}	Gate-Source Charge			32		
Q_{gd}	Gate-Drain ("Miller") Charge			111		
$t_{d(on)}$	Turn-on Delay Time	RESISTIVE SWITCHING $V_{GS} = 15V$ $V_{DD} = 550V$ $I_D = 22A @ 25^\circ C$ $R_G = 0.6\Omega$		18		ns
t_r	Rise Time			9		
$t_{d(off)}$	Turn-off Delay Time			45		
t_f	Fall Time			14		
E_{on}	Turn-on Switching Energy ⑥	INDUCTIVE SWITCHING @ 25°C $V_{DD} = 733V, V_{GS} = 15V$ $I_D = 22A, R_G = 5\Omega$		961		μJ
E_{off}	Turn-off Switching Energy			581		
E_{on}	Turn-on Switching Energy ⑥	INDUCTIVE SWITCHING @ 125°C $V_{DD} = 733V, V_{GS} = 15V$ $I_D = 22A, R_G = 5\Omega$		1812		
E_{off}	Turn-off Switching Energy			899		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I_S	Continuous Source Current (Body Diode)			26	Amps
I_{SM}	Pulsed Source Current ① (Body Diode)			104	
V_{SD}	Diode Forward Voltage ② ($V_{GS} = 0V, I_S = -26A$)			1.3	Volts
dv/dt	Peak Diode Recovery dv/dt ⑤			10	V/ns
t_{rr}	Reverse Recovery Time ($I_S = -26A, di/dt = 100A/\mu s$)	$T_j = 25^\circ C$		320	ns
		$T_j = 125^\circ C$		650	
Q_{rr}	Reverse Recovery Charge ($I_S = -26A, di/dt = 100A/\mu s$)	$T_j = 25^\circ C$	3.60		μC
		$T_j = 125^\circ C$	9.72		
I_{RRM}	Peak Recovery Current ($I_S = -26A, di/dt = 100A/\mu s$)	$T_j = 25^\circ C$	16.5		Amps
		$T_j = 125^\circ C$	24.7		

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			0.18	$^\circ C/W$
$R_{\theta JA}$	Junction to Ambient			40	

① Repetitive Rating: Pulse width limited by maximum junction temperature

② Pulse Test: Pulse width < 380 μs , Duty Cycle < 2%

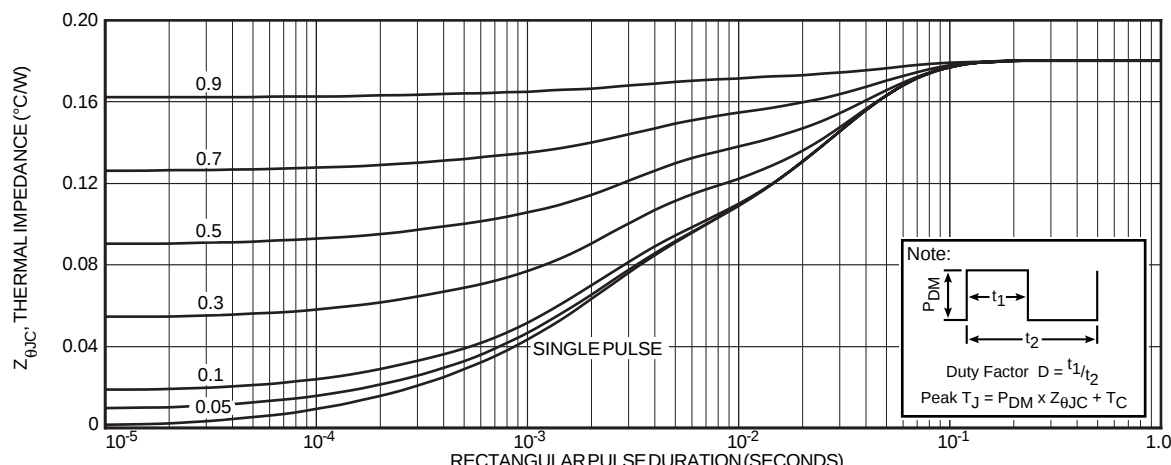
③ See MIL-STD-750 Method 3471

④ Starting $T_j = +25^\circ C$, $L = 8.88mH$, $R_G = 25\Omega$, Peak $I_L = 26A$

⑤ dv/dt numbers reflect the limitations of the test circuit rather than the device itself. $I_S \leq -26A$ $di/dt \leq 700A/\mu s$ $V_R \leq 1100$ $T_j \leq 150^\circ C$

⑥ E_{on} includes diode reverse recovery. See figures 18, 20.

APT Reserves the right to change, without notice, the specifications and information contained herein.



Typical Performance Curves

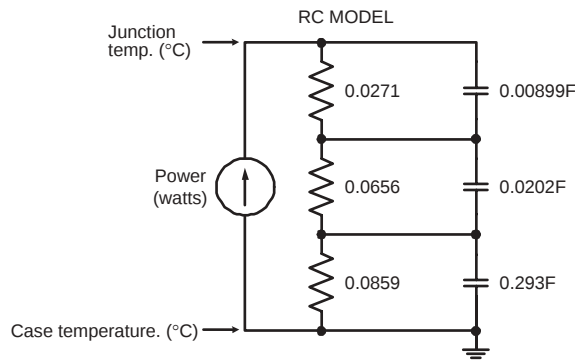
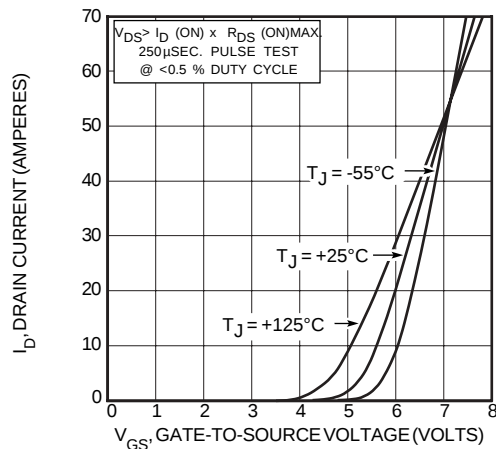


FIGURE 2, TRANSIENT THERMAL IMPEDANCE MODEL



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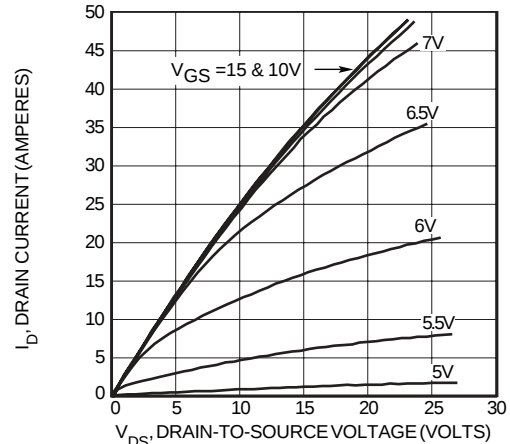


FIGURE 3, LOW VOLTAGE OUTPUT CHARACTERISTICS

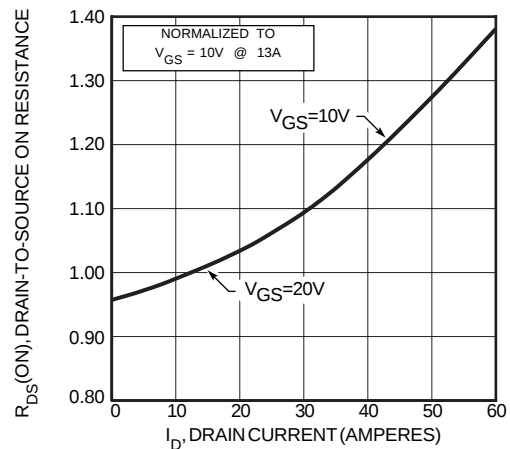


FIGURE 5, $R_{DS(ON)}$ vs DRAIN CURRENT

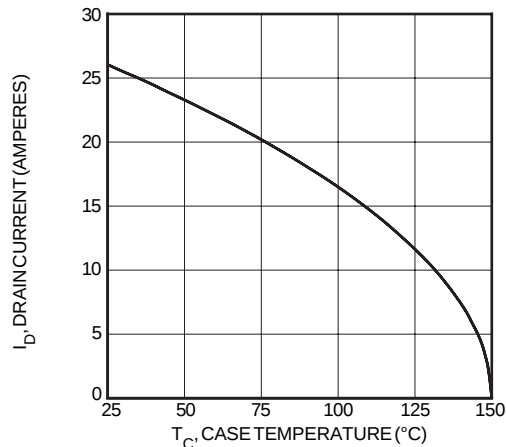


FIGURE 6, MAXIMUM DRAIN CURRENT vs CASE TEMPERATURE

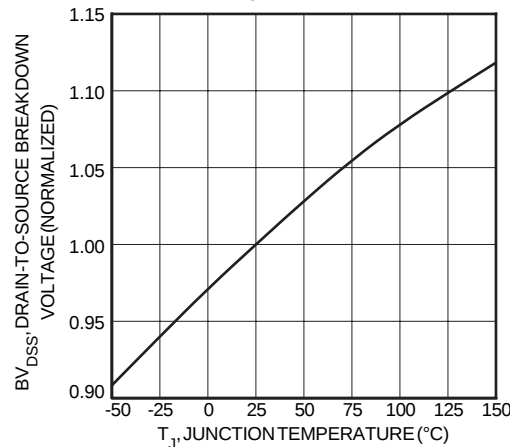


FIGURE 7, BREAKDOWN VOLTAGE vs TEMPERATURE

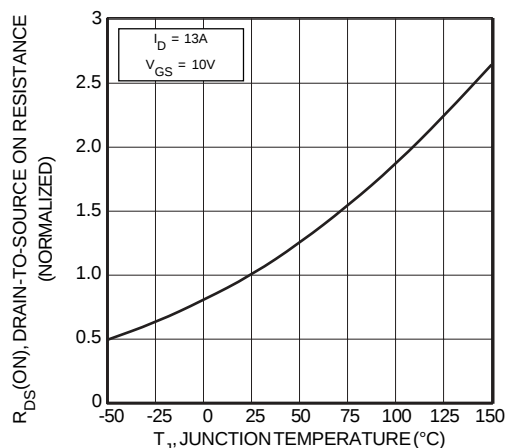


FIGURE 8, ON-RESISTANCE vs. TEMPERATURE

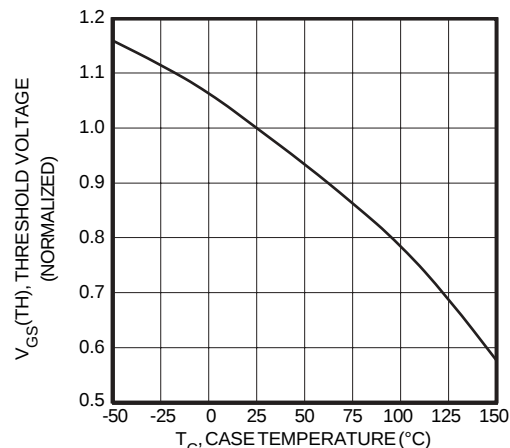


FIGURE 9, THRESHOLD VOLTAGE vs TEMPERATURE

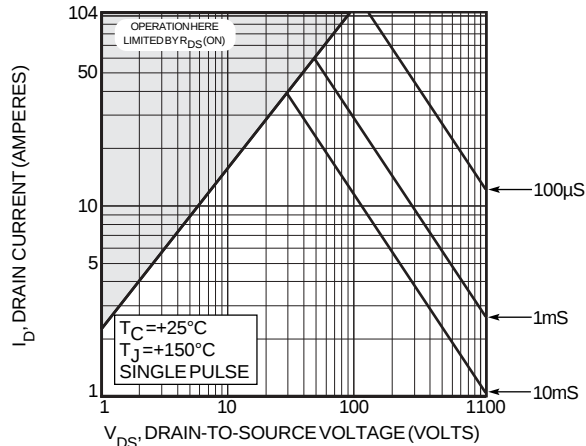


FIGURE 10, MAXIMUM SAFE OPERATING AREA

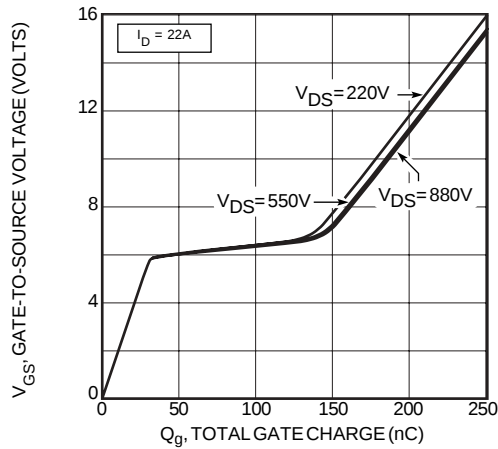


FIGURE 12, GATE CHARGES vs GATE-TO-SOURCE VOLTAGE

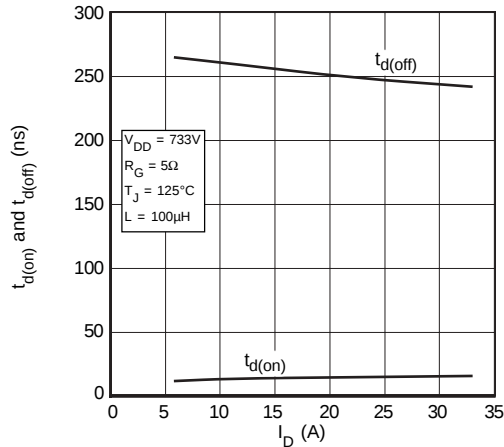


FIGURE 14, DELAY TIMES vs CURRENT

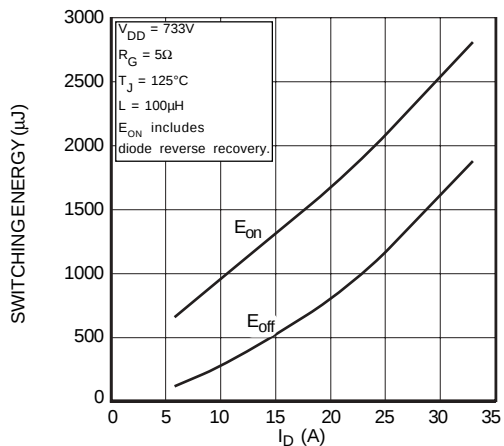


FIGURE 16, SWITCHING ENERGY vs CURRENT

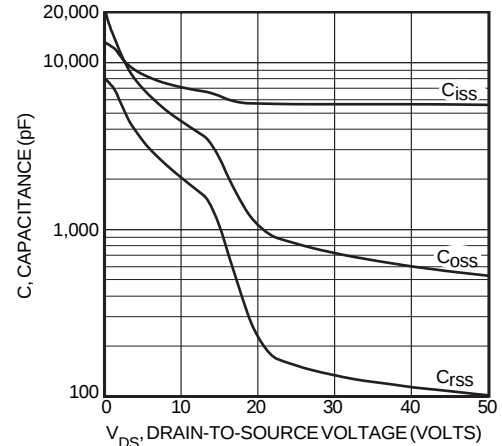


FIGURE 11, CAPACITANCE vs DRAIN-TO-SOURCE VOLTAGE

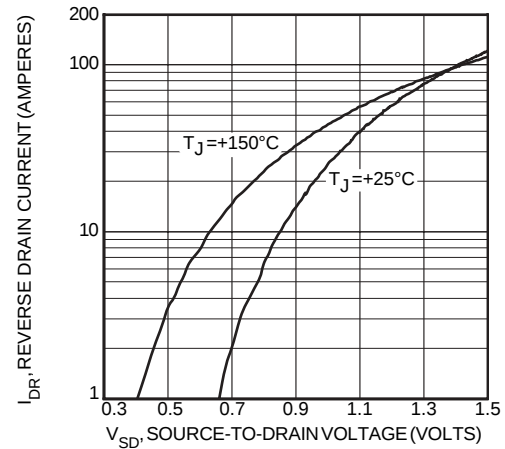


FIGURE 13, SOURCE-DRAIN DIODE FORWARD VOLTAGE

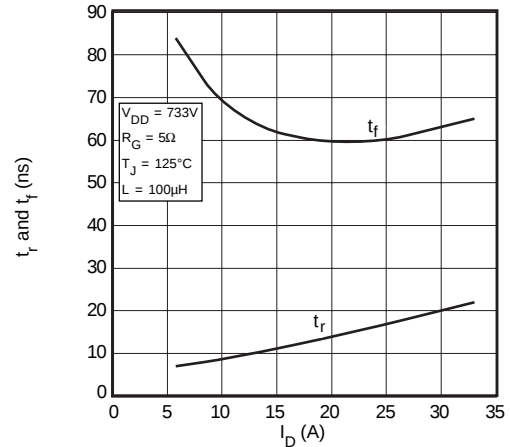


FIGURE 15, RISE AND FALL TIMES vs CURRENT

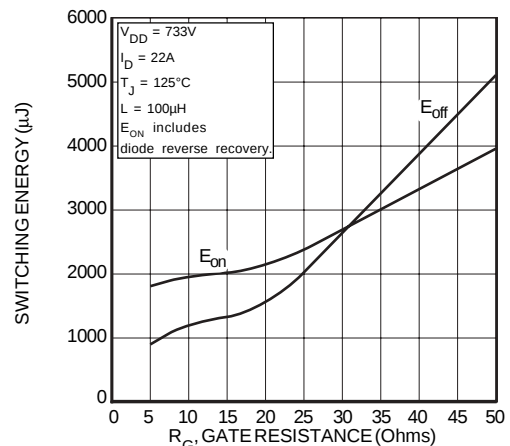


FIGURE 17, SWITCHING ENERGY vs. GATE RESISTANCE

APT11044B2FLL - LFLL

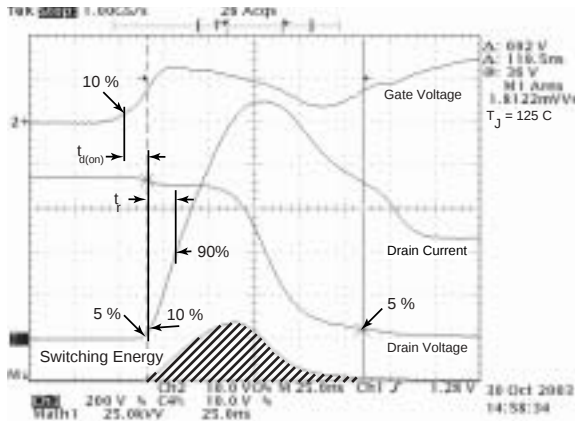


Figure 18, Turn-on Switching Waveforms and Definitions

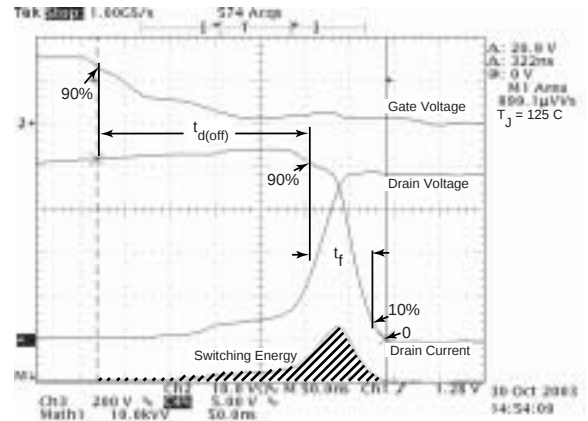


Figure 19, Turn-off Switching Waveforms and Definitions

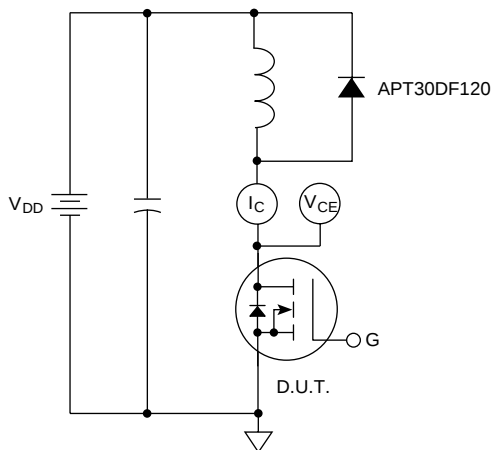
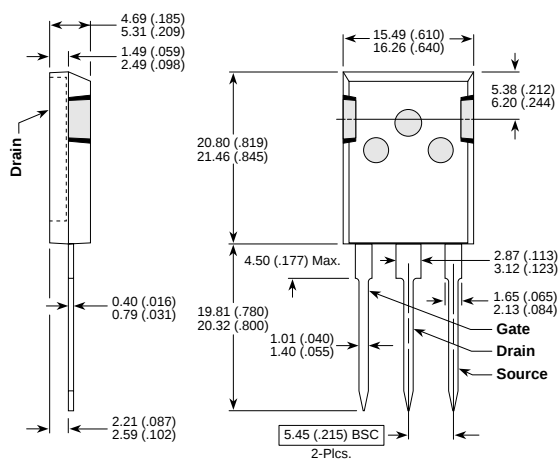


Figure 20, Inductive Switching Test Circuit

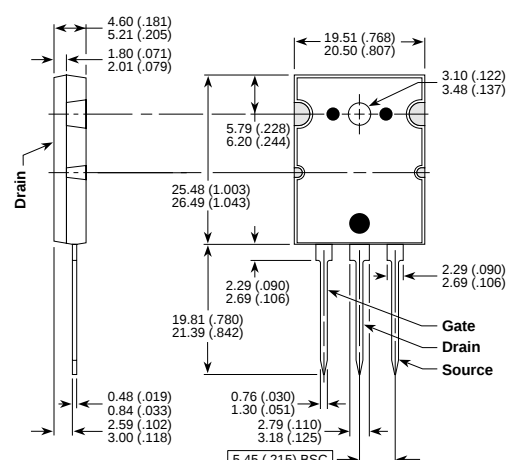
T-MAX™ (B2) Package Outline



These dimensions are equal to the TO-247 without the mounting hole.

Dimensions in Millimeters and (Inches)

TO-264 (L) Package Outline



Dimensions in Millimeters and (Inches)